

Unit in mm

Digital Logic Ground Isolation

Line Receiver

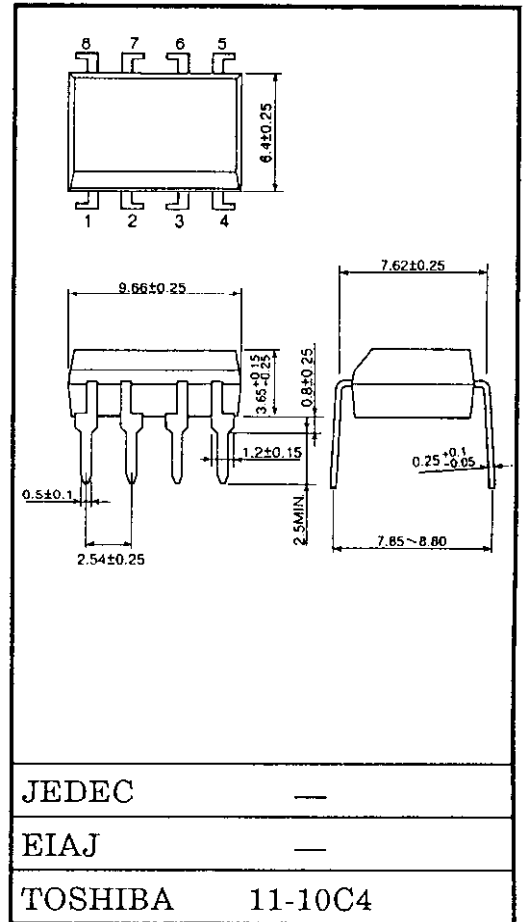
Microprocessor System Interfaces

Switching Power Supply Feedback Control

Analog Signal Isolation

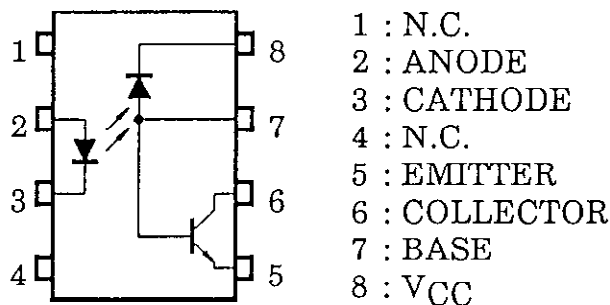
The Toshiba TLP651 consists of a GaAlAs high-output light emitting diode and a high speed detector of one chip photo diode-transistor. This unit is in an 8-lead DIP package. TLP651 has an internal base connection. This base pin should be used for analog applications or to enable operations. If the base pin is open, the output signal will be noisy depending on environmental conditions. In this case, TLP650 is suitable.

- Isolation Voltage : $5000V_{rms}$ (Min.)
- Switching Speed : $t_{pHL} = 0.3\mu s$ (Typ.)
: $t_{pLH} = 0.5\mu s$ (Typ.) ($R_L = 1.9k\Omega$)
- TTL Compatible
- UL Recognized : UL1577, File No. E67349

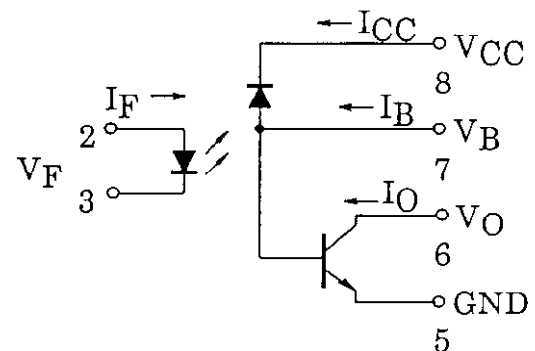


Weight : 0.54g

Pin Configuration (Top View)



Schematic



Supplementary Information	Page (s)
Lead Form Options	31-32
Tape and Reel	39-40
Current Transfer Ratio	29-31

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Maximum Ratings (Ta = 25°C)

CHARACTERISTIC		SYMBOL	RATING	UNIT
LED	Forward Current (Note 1)	I_F	25	mA
	Forward Current Derating (Note 2)	I_{FP}	50	mA
	Peak Transient Forward Current (Note 3)	I_{FPT}	1	A
	Reverse Voltage	V_R	5	V
	Diode Power Dissipation (Note 4)	P_D	45	mW
DETECTOR	Output Current	I_O	8	mA
	Peak Output Current	I_{OP}	16	mA
	Output Voltage	V_O	-0.5~15	V
	Supply Voltage	V_{CC}	-0.5~15	V
	Base Current	I_B	5	mA
	Emitter-Base Reverse Voltage	V_{EB}	5	V
	Output Power Dissipation (Note 5)	P_O	100	mW
Operating Temperature Range		T_{opr}	-55~100	°C
Storage Temperature Range		T_{stg}	-55~125	°C
Lead Soldering Temperature (10 sec.) (Note 6)		T_{sol}	260	°C
Total Package Power Dissipation		P_T	250	mW
Isolation Voltage (AC, 1 min, R.H. ≤ 60%) (Note 7)		BV_S	5000	V_{rms}

Note 1: Derate 0.8mA above 70°C.

Note 2: 50% duty cycle, 1ms pulse width. Derate 1.6mA/°C above 70°C.

Note 3: Pulse width ≤ 1μs, 300pps.

Note 4: Derate 0.9mW/°C above 70°C.

Note 5: Derate 2mW/°C above 70°C.

Note 6: Soldering portion of lead: up to 2mm from the body of the device.

Note 7: Device considered a two terminal device: Pins 1, 2, 3 and 4 shorted together and pins 5, 6, 7 and 8 shorted together.

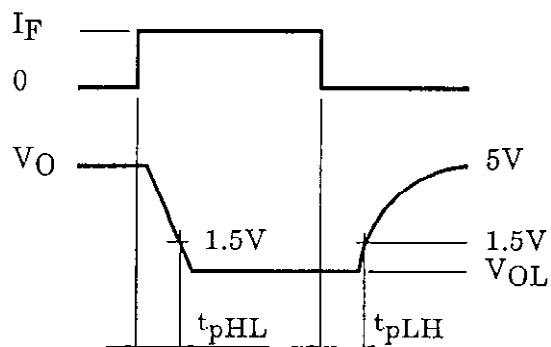
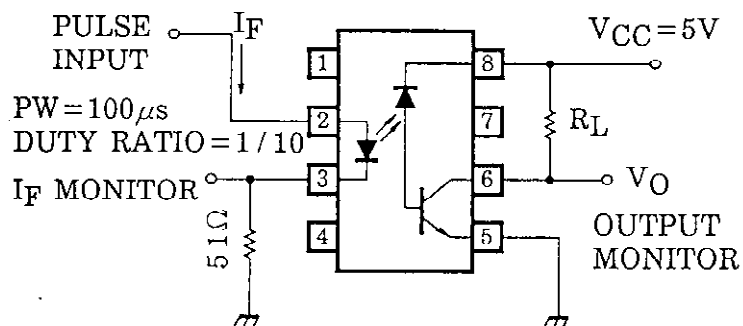
Electrical Characteristics (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MX.	UNIT	
LED	Forward Voltage	V_F	$I_F = 16\text{mA}$	–	1.65	1.85	V	
	Forward Voltage Temperature Coefficient	$\Delta V_F/\Delta T_a$	$I_F = 16\text{mA}$	–	-2	–	mV/°C	
	Reverse Current	I_R	$V_R = 5\text{V}$	–	–	10	μA	
	Capacitance Between Terminal	C_T	$V_F = 0, f = 1\text{MHz}$	–	45	–	pF	
DETECTOR	High Level Output Current	$I_{OH(1)}$	$I_F = 0\text{mA}, V_{CC} = V_O = 5.5\text{V}$	–	3	500	nA	
		$I_{OH(2)}$	$I_F = 0\text{mA}, V_{CC} = V_O = 15\text{V}$	–	–	5	μA	
		I_{OH}	$I_F = 0\text{mA}, V_{CC} = V_O = 15\text{V}$ $T_a = 70^\circ\text{C}$	–	–	250	μA	
	High Level Supply Voltage	I_{CCH}	$I_F = 0\text{mA}, V_{CC} = 15\text{V}$	–	0.01	1	μA	
COUPLED	Current Transfer Ratio	I_O/I_F	$I_F = 16\text{mA}$ $V_{CC} = 4.5\text{V}$ $V_O = 0.4\text{V}$	$T_a = 25^\circ\text{C}$	10	30	–	%
				Rank: 0	19	30	–	
				$T_a = 0\sim 70^\circ\text{C}$	5	–	–	
				Rank: 0	15	–	–	
	Low Level Output Voltage	V_{OL}	$I_F = 16\text{mA}, V_{CC} = 4.5\text{V},$ $I_O = 1.1\text{mA}$ (Rank 0: $I_O = 2.4\text{mA}$)	–	–	0.4	V	
Isolation Resistance	R_S	R.H. $\leq 60\%, V_S = 500\text{V}_{DC}$ (Note 7)	–	10^{12}	–	Ω		
Capacitance Between Input to Output	C_S	$V_S = 0, f = 1\text{MHz}$ (Note 7)	–	0.8	–	pF		

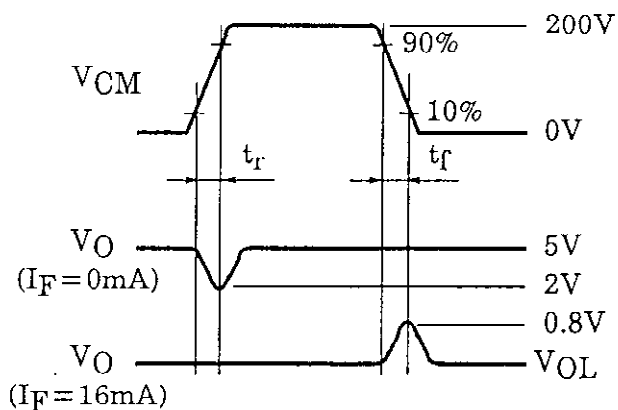
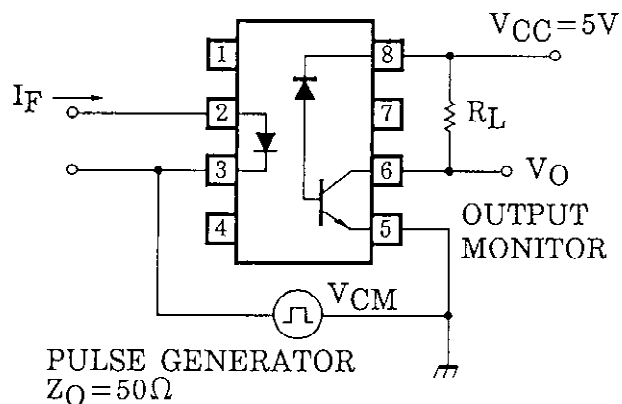
Switching Characteristics (Ta = 25°C)

CHARACTERISTIC	SYMBOL	TEST CIRCUIT	TEST CONDITION	MIN.	TYP.	MX.	UNIT
Propagation Delay Time (H→L)	t_{pHL}	1	$I_F = 0 \rightarrow 16\text{mA}, V_{CC} = 5\text{V},$	–	0.2	0.8	μs
			$R_L = 4.1\text{k}\Omega$ Rank 0: $R_L = 1.9\text{k}\Omega$	–	0.3	0.8	
Propagation Delay Time (L→H)	t_{pLH}	1	$I_F = 16 \rightarrow 0\text{mA}, V_{CC} = 5\text{V},$	–	1.0	2.0	μs
			$R_L = 4.1\text{k}\Omega$ Rank 0: $R_L = 1.9\text{k}\Omega$	–	0.5	1.2	
Common Mode Transient Immunity at Logic High Output (Note 8)	C_{MH}	2	$I_F = 0\text{mA}, V_{CM} = 200\text{Vp-p}$ $R_L = 4.1\text{k}\Omega$ (Rank 0: $R_L = 1.9\text{k}\Omega$)	–	400	–	V/ μs
Common Mode Transient Immunity at Logic Low Output (Note 8)	C_{ML}		$I_F = 16\text{mA}, V_{CM} = 200\text{Vp-p}$ $R_L = 4.1\text{k}\Omega$ (Rank 0: $R_L = 1.9\text{k}\Omega$)	–	-1000	–	V/ μs

TEST CIRCUIT 1 : Switching Time Test Circuit



TEST CIRCUIT 2 : Common Mode Noise Immunity Test Circuit



$$CM_H = \frac{160(V)}{t_r(\mu s)}, \quad CM_L = \frac{160(V)}{t_f(\mu s)}$$

